APR 14 2005

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PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q67964

Masamoto TAGO, et al.

Allowed: March 25, 2005

Appln. No.: 10/043,225

Group Art Unit: 2811

Confirmation No.: 4956

Examiner: Nitin PAREKH

Filed: January 14, 2002

For:

SEMICONDUCTOR DEVICE, MANUFACTURING METHOD AND APPARATUS

FOR THE SAME

INFORMATION DISCLOSURE STATEMENT UNDER 37 C.F.R. §§ 1.97 and 1.98

MAIL STOP ISSUE FEE

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In accordance with the duty of disclosure under 37 C.F.R. § 1.56, Applicant hereby notifies the U.S. Patent and Trademark Office of the document which is listed on the attached PTO/SB/08 A & B (modified) form and listed herein and which the Examiner may deem material to patentability of the claims of the above-identified application.

1. Korean Patent Publication No. 1995-8844, published August 8, 1995.

One copy of the listed document is submitted herewith.

The present Information Disclosure Statement is being filed after either a Final Office Action, Notice of Allowance, or an action that otherwise closes prosecution in the application (whichever is earlier), but before payment of the Issue Fee, and therefore Applicant is submitting herewith a check for the fee of \$180.00 under 37 C.F.R. § 1.17(p), and a Statement Under 37 C.F.R. § 1.97(e).

04/15/2005 HALI11 00000054 10043225

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INFORMATION DISCLOSURE STATEMENT

U.S. Appln. No.: 10/043,225

Atty. Docket No.: Q67964

In compliance with the concise explanation requirement under 37 C.F.R. § 1.98(a)(3) for

foreign language documents, Applicant encloses here with a copy of a corresponding Korean

Office Action dated February 25, 2005, and an English translation of the pertinent portions

thereof which cites such documents and indicates the degree for relevance found by the foreign

office.

The submission of the listed documents is not intended as an admission that any such

document constitutes prior art against the claims of the present application. Applicant does not

waive any right to take any action that would be appropriate to antedate or otherwise remove any

listed document as a competent reference against the claims of the present application.

The USPTO is directed and authorized to charge all required fees, except for the Issue

Fee and the Publication Fee, to Deposit Account No. 19-4880. Please also credit any

overpayments to said Deposit Account. A duplicate copy of this paper is attached.

Respectfully submitted,

Howard L. Bernstein

Registration No. 25,665

SUGHRUE MION, PLLC

Telephone: (202) 293-7060

Facsimile: (202) 293-7860

WASHINGTON OFFICE

23373

CUSTOMER NUMBER

Date: April 14, 2005

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Q67964

INFORMATION DISCLOSURE STATEMENT BY APPLICANT (use as many sheets as necessary)	Complete if Known		
	Application Number	10/043,225	
INFORMATION DISCLOSURE	Confirmation Number	4956	
	Filing Date	January 14, 2002	
DIMILIMIDITE DE METERS	First Named Inventor	Masamoto TAGO	
(use as many sheets as necessary)	Art Unit	2811	
, J	Examiner Name	Nitin PAREKH	

Attorney Docket Number

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	U.S. PATENT DOCUMENTS						
	Examiner	Cite	Document Number		Publication Date		
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	FOREIGN PATENT DOCUMENTS						
Examiner	Cite	Fo	reign Patent Docui	nent	Publication Date MM-DD-YYYY	Name of Patentee or	Translation ⁶
Initials*	No.1	Country Code ³	Number ⁴	Kind Code ⁵ (if known)		Applicant of Cited Document	
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		NON PATENT LITERATURE DOCUMENTS	
Examiner Initials*	Cite No.1	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city, and/or country where published.	Translation ⁶
			<u> </u>

Examiner Signature	Date Co	onsidered

^{*}EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

¹Applicant's unique citation designation number (optional). ²See Kind Codes of USPTO Patent Documents at www.uspto.gov, MPEP 901.04 or in the comment box of this document. ³ Enter Office that issued the document, by the two-letter code (WIPO Standard ST. 3). ⁴For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. ⁶ Applicant is to indicate here if English language Translation is attached.

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FOR THE SAME

STATEMENT UNDER 37 C.F.R. § 1.97(e)

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

The undersigned hereby states, upon information and belief:

That each item of information contained in the Information Disclosure Statement filed concurrently herewith was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of said Information Disclosure Statement.

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Date: April 14, 2005

Respectfully submitted,

Howard L. Bernstein Registration No. 25,665

Q67964

Patent Claims 39, 40, and 42 through 44 of the Amendment of the Specification, etc. dated December 30, 2004, submitted in response to a decision of rejection dated September 30, 2004, relate to a semiconductor manufacturing device, characterized in that it comprises a stage for placing specimens, a heating unit for heating said specimens, and a cooling unit for cooling said specimens from below. To compare this arrangement to Korean Patent Publication 1995-8844 (hereinafter, the "Cited Invention"), which describes a technical arrangement relating to a stage, a semiconductor board, a heating unit, and a cooling unit, the two are similar in the point of comprising a heating unit for heating and a cooling unit for cooling a specimen or wafer, and are similar also in their effect. Therefore, it is found that Claims 39 and 42 through 44 of the Amendment of the Specification, etc., dated December 30, 2004, of the invention of the present application, could have been easily invented by a person having ordinary knowledge in this field on the basis of the aforementioned Cited Invention.

(ATTACHMENTS)

Attachment 1 Korean Patent Publication 1995-8844 1 copy

END